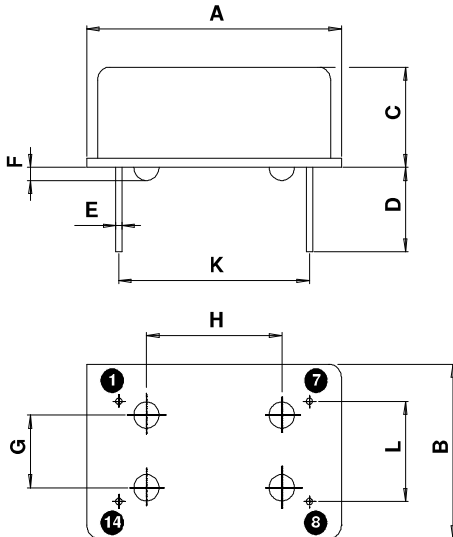


Package dimension: Through holes version



Dimensions (typ.):

	In.	mm
A	0.80 ±0.003	20.14 ±0.08
B	0.493 ±0.003	12.52 ±0.08
C	0.307 ±0.008	7.8 ±0.2
D	0.25 ±0.002	6.35 ±0.5
E	0.018 ±0.0025	0.46 ±0.06
F	0.032 ±0.006	0.8 ±0.15
G	0.21 ±0.005	5.35 ±0.13
H	0.42 ±0.005	10.7 ±0.13
K	0.60 ±0.005	15.24 ±0.13
L	0.30 ±0.005	7.62 ±0.13

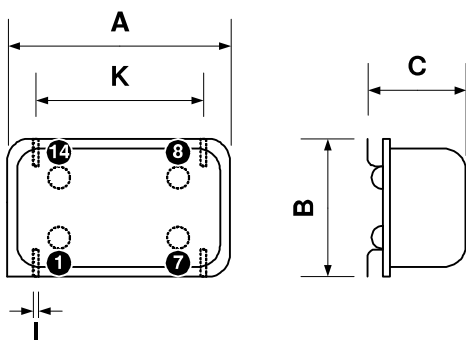
Pin Out:

1	Frequency adjustment
7	GND
8	Output
14	Vcc

Recommended pins soldering:

235 °C ±5 °C, t = 10s ±0.5s
(260 °C max for 5s max)

Package dimension: SMD version (option D2):



Dimensions (typ.):

	In.	mm
A	0.80 ±0.003	20.14 ±0.08
B	0.493 ±0.003	12.52 ±0.08
C	0.374 ±0.008	9.5 ±0.2
K	0.60 ±0.005	15.24 ±0.13
I	0.018 ±0.0025	0.46 ±0.06

Pin Out:

1	Frequency adjustment
7	GND
8	Output
14	Vcc

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**In accordance with our policy of continuous development and improvement,
we reserve the right to modify the design or the specifications of our products without prior notice.**

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